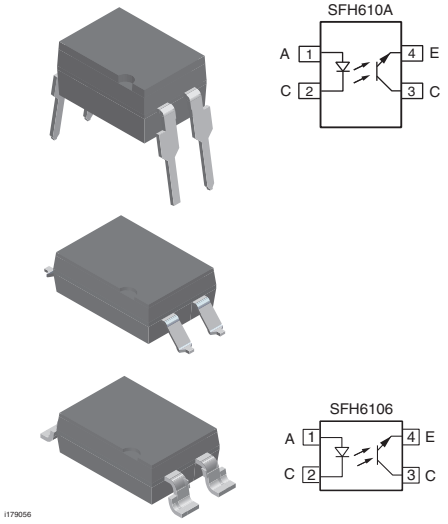
Optocoupler, Phototransistor Output, High Reliability, 5300 V_{RMS}



FEATURES

- Good CTR linearity depending on forward current
- Isolation test voltage, 5300 V_{RMS}
- High collector emitter voltage, V_{CEO} = 70 V
- Low saturation voltage
- Fast switching times
- Low CTR degradation
- Temperature stable
- Low coupling capacitance
- End stackable, 0.100" (2.54 mm) spacing
- High common mode interference immunity
- Lead (Pb)-free component
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Pb-free
e3
RoHS COMPLIANT

DESCRIPTION

The SFH610A (DIP) and SFH6106 (SMD) feature a high current transfer ratio, low coupling capacitance and high isolation voltage. These couplers have a GaAs infrared diode emitter, which is optically coupled to a silicon planar phototransistor detector, and is incorporated in a plastic DIP-4 or SMD package.

The coupling devices are designed for signal transmission between two electrically separated circuits.

The couplers are end-stackable with 2.54 mm spacing.

Creepage and clearance distances of > 8.0 mm are achieved with option 6. This version complies with IEC 60950 (DIN VDE 0805) for reinforced insulation up to an operation voltage of 400 V_{RMS} or DC. Specifications subject to change.

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- CSA 93751
- BSI IEC 60950; IEC 60065

ORDERING INFORMATION

PART	REMARKS
SFH610A-1	CTR 40 % to 80 %, DIP-4
SFH610A-2	CTR 63 % to 125 %, DIP-4
SFH610A-3	CTR 100 % to 200 %, DIP-4
SFH610A-4	CTR 160 % to 320 %, DIP-4
SFH610A-5	CTR 250 % to 500 %, DIP-4
SFH6106-1	CTR 40 % to 80 %, SMD-4
SFH6106-2	CTR 63 % to 125 %, SMD-4
SFH6106-3	CTR 100 % to 200 %, SMD-4
SFH6106-4	CTR 160 % to 320 %, SMD-4
SFH6106-5T	CTR 250 % to 500 %, SMD-4, tape and reel
SFH610A-1X006	CTR 40 % to 80 %, DIP-4 400 mil
SFH610A-1X018T	CTR 40 % to 80 %, SMD-4 400 mil, wide leadspread
SFH610A-2X006	CTR 63 % to 125 %, DIP-4 400 mil
SFH610A-3X006	CTR 100 % to 200 %, DIP-4 400 mil
SFH610A-3X007	CTR 100 % to 200 %, SMD-4
SFH610A-4X006	CTR 160 % to 320 %, DIP-4 400 mil

Note

- For additional information on the available options refer to option information.

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
INPUT				
Reverse voltage		V_R	6	V
DC forward current		I_F	60	mA
Surge forward current	t ≤ 10 µs	I_{FSM}	2.5	A
Power dissipation		P_{diss}	100	mW
OUTPUT				
Collector emitter voltage		V_{CE}	70	V
Emitter collector voltage		V_{EC}	7	V
Collector current		I_C	50	mA
	t_p ≤ 1.0 ms	I_C	100	mA
Power dissipation		P_{diss}	150	mW
COUPLER				
Isolation test voltage between emitter and detector		V_{ISO}	5300	V_{RMS}
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness between emitter and detector			≥ 0.4	mm
Comparative tracking index per DIN IEC112/VDE 0303 part 1			≥ 175	
Isolation resistance	V_{IO} = 500 V, T_{amb} = 25 °C	R_{IO}	≥ 10^{12}	Ω
	V_{IO} = 500 V, T_{amb} = 100 °C	R_{IO}	≥ 10^{11}	Ω
Storage temperature range		T_{stg}	- 55 to + 150	°C
Ambient temperature range		T_{amb}	- 55 to + 100	°C
Soldering temperature (1)	max. 10 s, dip soldering distance to seating plane ≥ 1.5 mm	T_{sld}	260	°C

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)							
PARAMETER	**TEST CONDITION**	**PART**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
INPUT							
Forward voltage	I_F = 60 mA		V_F		1.25	1.65	V
Reverse current	V_R = 6 V		I_R		0.01	10	µA
Capacitance	V_R = 0 V, f = 1 MHz		C_O		13		pF
Thermal resistance			R_{thja}		750		K/W
OUTPUT							
Collector emitter capacitance	V_{CE} = 5 V, f = 1 MHz		C_{CE}		5.2		pF
Thermal resistance			R_{thja}		500		K/W
Collector emitter leakage current	V_{CE} = 10 V	SFH610A-1	I_{CEO}		2	50	nA
		SFH6106-1	I_{CEO}		2	50	nA
		SFH610A-2	I_{CEO}		2	50	nA
		SFH6106-2	I_{CEO}		2	50	nA
		SFH610A-3	I_{CEO}		5	100	nA
		SFH6106-3	I_{CEO}		5	100	nA
		SFH610A-4	I_{CEO}		5	100	nA
		SFH6106-4	I_{CEO}		5	100	nA
		SFH610A-5	I_{CEO}		5	100	nA
		SFH6106-5T	I_{CEO}		5	100	nA

ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)							
PARAMETER	**TEST CONDITION**	**PART**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
COUPLER							
Collector emitter saturation voltage	I_F = 10 mA, I_C = 2.5 mA		V_{CEsat}		0.25	0.4	V
Coupling capacitance	f = 1 MHz		C_C		0.4		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO							
PARAMETER	**TEST CONDITION**	**PART**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
I_C/I_F	I_F = 10 mA, V_{CE} = 5.0 V	SFH610A-1	CTR	40		80	%
		SFH6106-1	CTR	40		80	%
		SFH610A-2	CTR	63		125	%
		SFH6106-2	CTR	63		125	%
		SFH610A-3	CTR	100		200	%
		SFH6106-3	CTR	100		200	%
		SFH610A-4	CTR	160		320	%
		SFH6106-4	CTR	160		320	%
		SFH610A-5	CTR	250		500	%
		SFH6106-5T	CTR	250		500	%
	I_F = 1 mA, V_{CE} = 5 V	SFH610A-1	CTR	13	30		%
		SFH6106-1	CTR	13	30		%
		SFH610A-2	CTR	22	45		%
		SFH6106-2	CTR	22	45		%
		SFH610A-3	CTR	34	70		%
		SFH6106-3	CTR	34	70		%
		SFH610A-4	CTR	56	90		%
		SFH6106-4	CTR	56	90		%

SWITCHING CHARACTERISTICS							
PARAMETER	**TEST CONDITION**	**PART**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
NON-SATURATED							
Current	V_{CC} = 5 V, R_L = 75 Ω		I_F		10		mA
Rise time	V_{CC} = 5 V, R_L = 75 Ω		t_r		2		µs
Fall time	V_{CC} = 5 V, R_L = 75 Ω		t_f		2		µs
Turn-on time	V_{CC} = 5 V, R_L = 75 Ω		t_{on}		3		µs
Turn-off time	V_{CC} = 5 V, R_L = 75 Ω		t_{off}		2.3		µs
Cut-off frequency	V_{CC} = 5 V		F_{CO}		250		kHz
SATURATED							
Current		SFH610A-1	I_F		20		mA
		SFH6106-1					
		SFH610A-2	I_F		10		mA
		SFH6106-2					
		SFH610A-3	I_F		10		mA
		SFH6106-3					
		SFH610A-4	I_F		5		mA
		SFH6106-4					

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
SATURATED							
Rise time		SFH610A-1	t_r		2		µs
		SFH6106-1					
		SFH610A-2	t_r		3		µs
		SFH6106-2					
		SFH610A-3	t_r		3		µs
		SFH6106-3					
		SFH610A-4	t_r		4		µs
		SFH6106-4					
Fall time		SFH610A-1	t_f		11		µs
		SFH6106-1					
		SFH610A-2	t_f		14		µs
		SFH6106-2					
		SFH610A-3	t_f		14		µs
		SFH6106-3					
		SFH610A-4	t_f		15		µs
		SFH6106-4					
Turn-on time		SFH610A-1	t_{on}		3		µs
		SFH6106-1					
		SFH610A-2	t_{on}		4.2		µs
		SFH6106-2					
		SFH610A-3	t_{on}		4.2		µs
		SFH6106-3					
		SFH610A-4	t_{on}		6		µs
		SFH6106-4					
Turn-off time		SFH610A-1	t_{off}		18		µs
		SFH6106-1					
		SFH610A-2	t_{off}		23		µs
		SFH6106-2					
		SFH610A-3	t_{off}		23		µs
		SFH6106-3					
		SFH610A-4	t_{off}		25		µs
		SFH6106-4					

Note

- All values presented are typical values.

SAFETY AND INSULATIO RATINGS						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Climatic classification (according to IEC 68 part 1)				55/100/21		
Comparative tracking index		CTI	175		399	
V_{IOTM}			10000			V
V_{IORM}			890			V
P_{SO}					400	mW
I_{SI}					275	mA
T_{SI}					175	°C
Creepage distance	standard DIP-4		7			mm
Clearance distance	standard DIP-4		7			mm
Creepage distance	400 mil DIP-4		8			mm
Clearance distance	400 mil DIP-4		8			mm
Insulation thickness, reinforced rated	per IEC 60950 2.10.5.1		0.4			mm

Note

- As per IEC 60747-5-2, § 7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

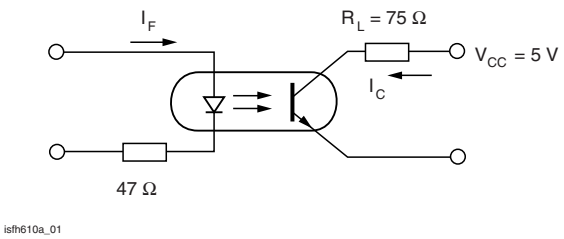


Fig. 1 - Linear Operation (without saturation)

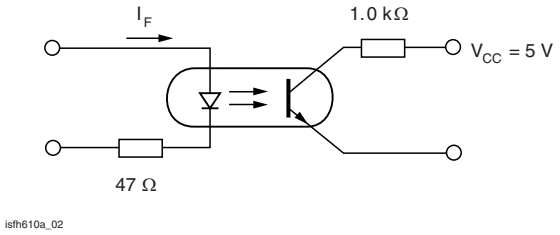


Fig. 3 - Switching Operation (with saturation)

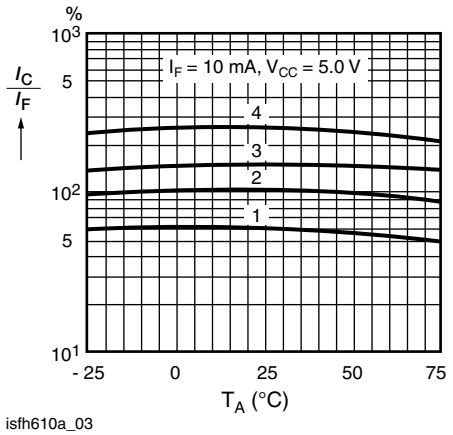


Fig. 2 - Current Transfer Ratio (CTR) vs. Temperature

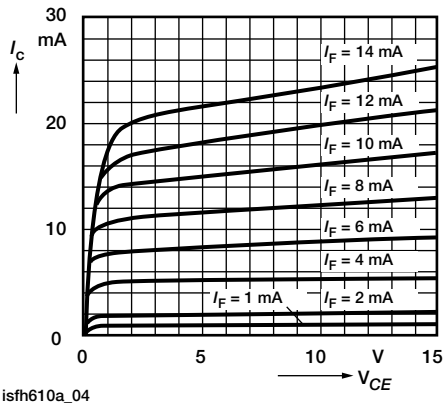


Fig. 4 - Output Characteristics (typ.) Collector Current vs. Collector Emitter Voltage

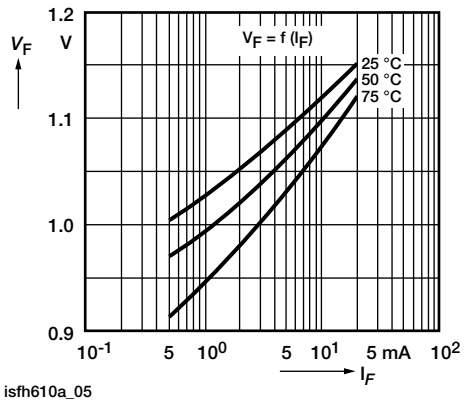


Fig. 5 - Diode Forward Voltage vs. Forward Current

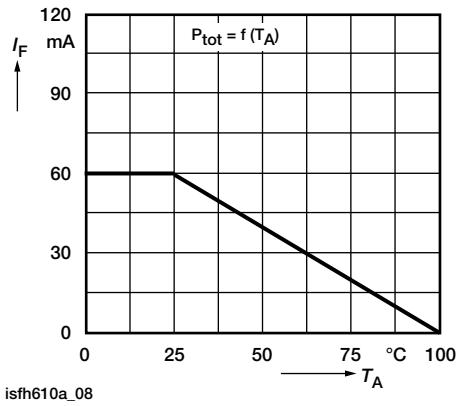


Fig. 8 - Permissible Power Dissipation vs. Temperature

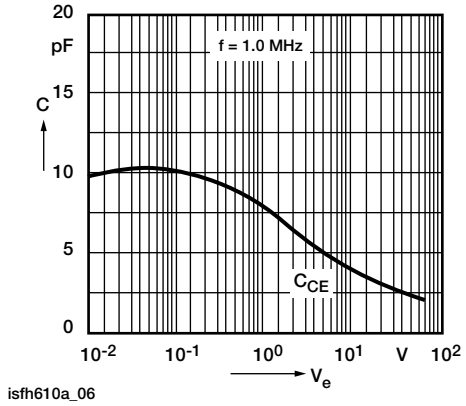


Fig. 6 - Transistor Capacitance (typ.) vs. Collector Emitter Voltage

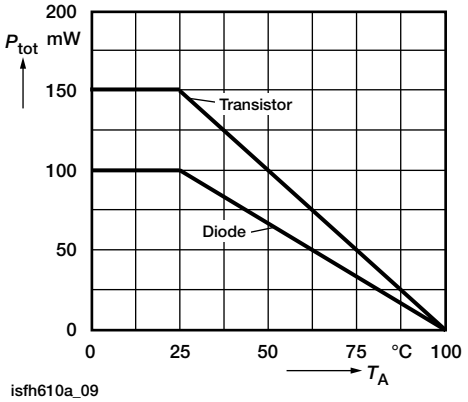


Fig. 9 - Permissible Diode Forward Current vs. Ambient Temperature

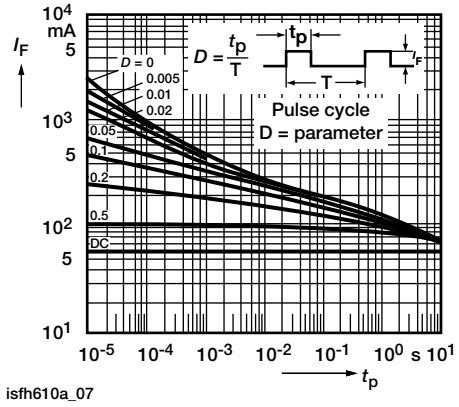
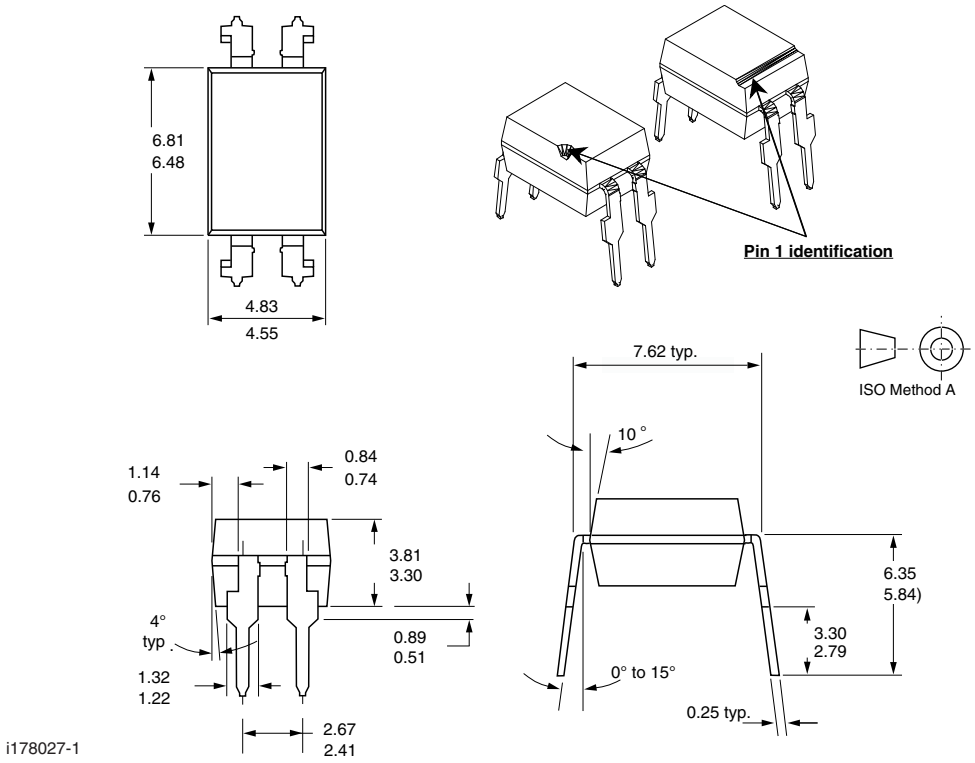
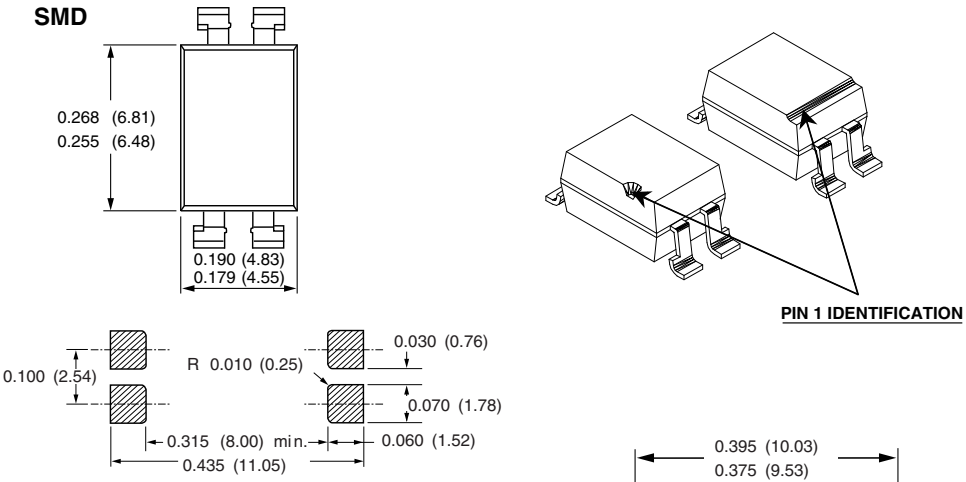


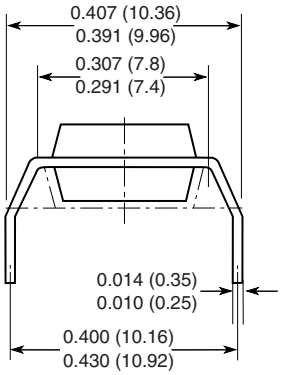
Fig. 7 - Permissible Pulse Handling Capability Forward Current vs. Pulse Width

PACKAGE DIMENSIONS in inches (millimeters)

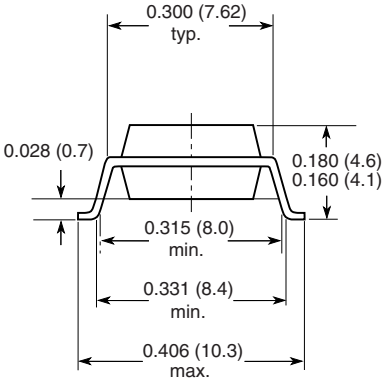




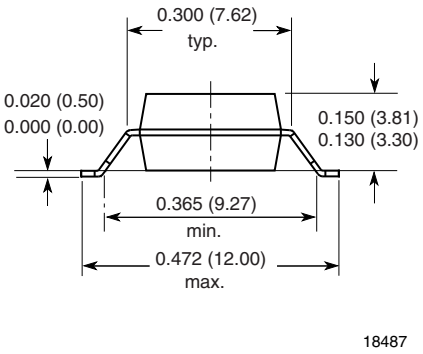
Option 6



Option 7



Option 8



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